



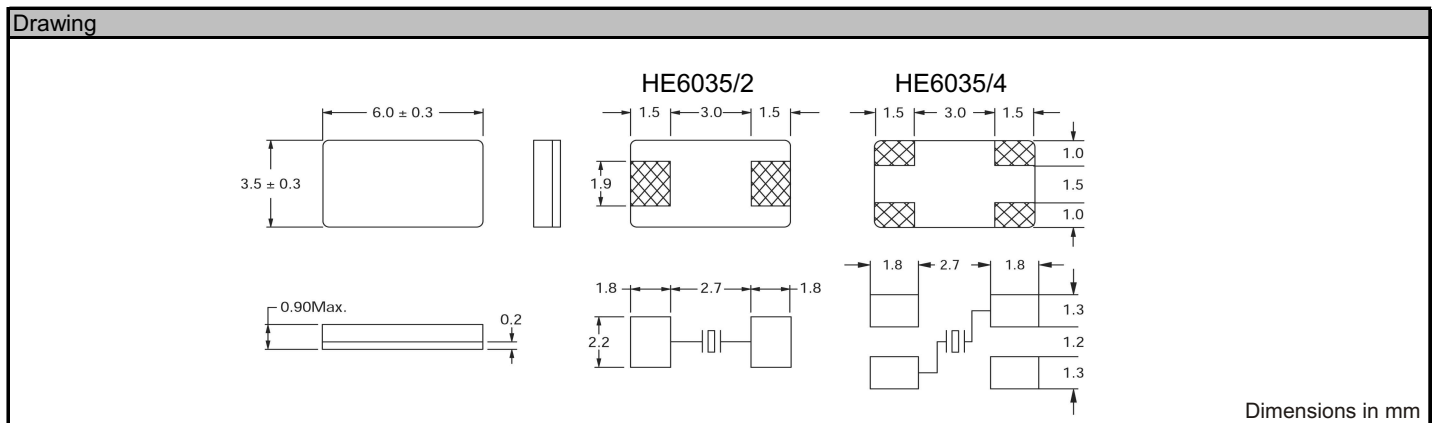
**HE6035/2**  
**HE6035/4**

Features:

- Application: Bluetooth, wireless LAN
- Ultra-thin and small leadless type
- Automatic mounting is enabled by emboss taping
- Reflow soldering
- RoHS conform

Specifications				
		Symbol	HE6035	Remarks
Frequency range		f	12.000MHz ~ 40.000MHz	Fundamental mode
Frequency tolerance, Ta=25°C		f/f	± 30ppm ~ ±50ppm	Please specify
Load capacitance		CL	10pF ~ 30 pF	Please specify
Temperature tolerance		f/f	± 30ppm ~ ± 50ppm	Please specify
Temperature range	Storage temperature	T <sub>STG</sub>	-30°C ~ +85°C	
	Operating temperature	T <sub>OPR</sub>	-10°C ~ +60°C	Others are offered
Drive level	Maximum drive level	M <sub>DL</sub>	500 W	
	Recommended drive level	R <sub>DL</sub>	20 W ~ 100 W	
Series resistance		R <sub>1</sub>	As per table	25°C
Shunt capacitance		C <sub>0</sub>	7pF	Max
Insulation resistance		I <sub>R</sub>	500M Ohm	Min
Aging		f <sub>A</sub>	± 5ppm/Year	

Resistance of series resonance (ESR)						
Frequency (MHz)	Mode	Ohm max		Frequency (MHz)	Mode	Ohm max
12 – 16	Fundamental	80		16 – 40	Fundamental	50



Order key								
Q	- 30.000000M	- HE6035/2	- F	- 50	- 50	- B	- 30	- TR
Part	Frequency	Package	Mode of oscillation	Frequency tolerance	Temperature tolerance	Temperature range	Load capacitance	Option
Q=Quartz	M=MHz	HE6035/2 HE6035/4	F=fund.	+/-ppm (25°C)	+/-ppm (Temp. range)	A= 0°C ~ 70°C B=-10°C ~ 60°C C=-10°C ~ 70°C D=-20°C ~ 70°C H=-20°C ~ +80°C I=-10°C ~ +50°C	pF SR=series	TR=Tape and reel X=Special options
		/2 = 2 pads /4 = 4 pads						

Remarks: All specifications subject to change without notice!